intel Technical Advisory

TA-223-1

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October 18, 1999

SECC processor packaging not supported with Grounded Retention Mechanisms (GRMs) on L440GX+ Server Boards

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Products Affected

BOXL440GXC MM# 825642, LWBBS MM# 825452

Description

L440GX+ server boards, with PBA# 704293-50x or AA# 721242-008 and greater, use Grounded Retention Mechanisms (GRM) to seat the Pentium® III processors to the server board. The new GRMs will only support processors manufactured with the SECC2 packaging. Older Pentium II or Pentium III processors that have SECC type processor packaging will not fit into the new GRMs. Customers can continue to use the Universal Retention Mechanism (URM) to support processors in the SECC package on L440GX+ server boards having the previously mentioned PBA and AA numbers.

Root Cause

NA

Corrective Action / Resolution

NA

Workarounds

NA.

Please contact your Intel Sales Representative if you require more specific information about this issue.

Entry/Mid-range Server Division Enterprise Servers Group Intel Corporation

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